

# SURGiNG

紹 鑫 實 業



# SurgeArresters

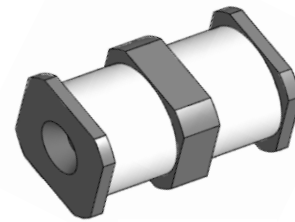
陶瓷气体放电管

SE6 Series

### Features

- Surface Mounting Design 6.8×3.5×3.5mm Current
- Current Handling Capability 2,000A @ 8/20μs
- Low Capacitance and Insertion Loss
- Fast Response and Long Service Life
- Reliable to Protect Electrostatic Surge
- Moisture sensitivity level: Level 1

### Exterior

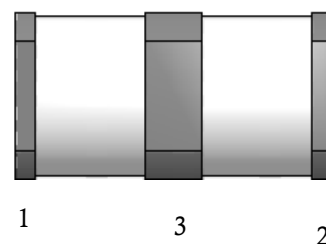


SMD

### Application information

- ESD protection
- xDSL
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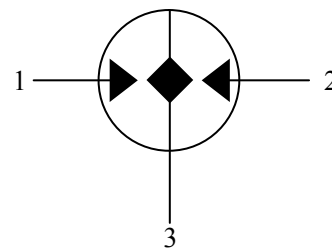
### Package (Top View)



### Agency Approvals

Icon	Description
<b>RoHS</b>	Compliance with 2011/65/EU
<b>HF</b>	Compliance with IEC61249-2-21:2003
	Mean lead free

### Schematic Symbol



### Electrical Parameter

DC Breakdown Voltage 1)2)	100V/s	360-560	V
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values	≤ 950
	At 1kV/μs	Typical values of distribution	≤ 850
Impulse Discharge Voltage 3)	10/700μs	6,000	V
Impulse Discharge Current 3)	8/20μs	2,000	A
Arc Voltage	At 1A	~20	V
Insulation Resistance	DC=100V	≥1	GΩ
C(1MHz)	VDC=0.5V	≤1.0	pF
Weight		~0.33	g
Operating And Storage Temperature		-40-90	°C
Marking		Without	

1) At delivery AQL 0.65 level II GB/T 2828.1-2003

2) In ionized mode

3) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21

## Part Numbering System

SE60 420X

(1) (2)

(1) SURGiNG3-Electrode SMD Gas Discharge Tube

(2) DC Breakdown Voltage, e.g., 420X =420V

## Product Characteristics

Lead Material	Copper
Body Material	Ceramics
Terminal Finish	100% Matte-Tin Plated

## Environmental Reliability Characteristics

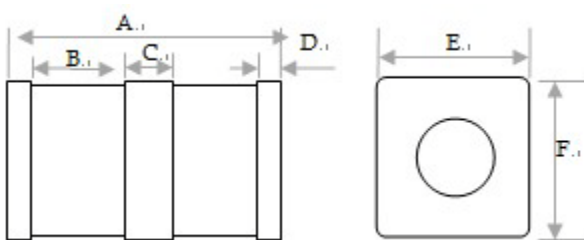
Testing items	Technical standards
High Temperature Storage Test	Temperature: 85°C Time:2H
Low Temperature Storage Test	Temperature: -40°C Time:2H
Vibration	Frequency: 10-500Hz Amplitude: 0.15mm Time: 45mins
Resistance of soldering heat	Temperature: 260±5°C Time of dip soldering: 10s, 1time

Note: Up-screen program can be specified by customer's request via contacting SURGiNG service

## Solderability Test

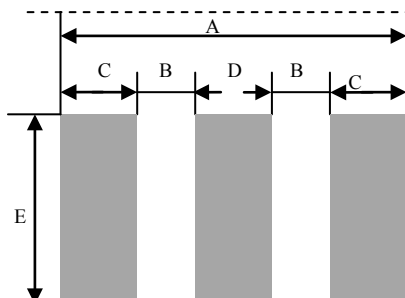
Solderability	Solder Pot Temperature:	245°C ± 5°C
	Solder Dwell Time:	4-6 seconds

## Product Dimensions



REF	mm	inch
A	6.8±0.2	0.268±0.008
B	2.4±0.15	0.094±0.006
C	1.2±0.1	0.047±0.004
D	0.4±0.1	0.016±0.004
E	3.5±0.15	0.138±0.006
F	3.5±0.15	0.138±0.006

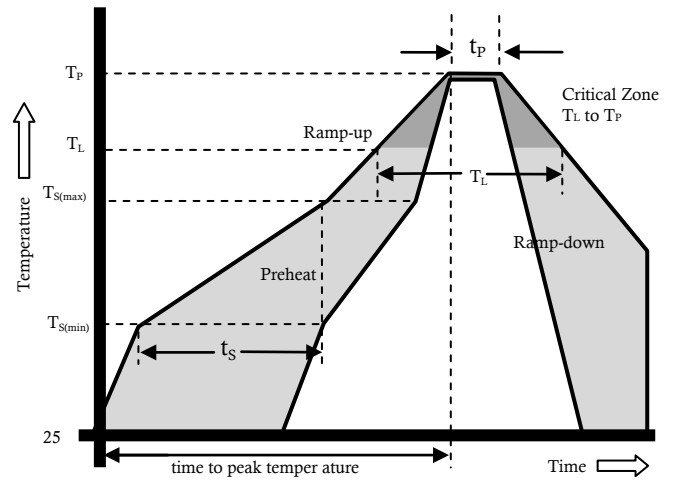
## Recommended Soldering Pad



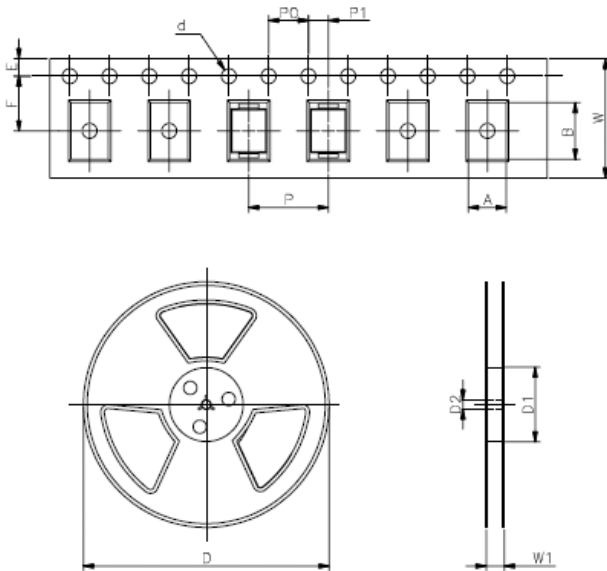
REF	mm	inch
A	8.10	0.217
B	1.75	0.138
C	1.40	0.055
D	1.80	0.071
E	4.20	0.165

Reflow Profile

Reflow Condition		Pb-Free assembly
Pre Heat	Temperature Min	150°C
	Temperature Max	200°C
	Time (min to max)	60 – 180 secs
Average ramp up rate (Liquids) T <sub>amp</sub> (T <sub>L</sub> ) to peak		3°C/second max
T <sub>S</sub> (max) to T <sub>L</sub> - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T <sub>L</sub> ) (Liquids)	217°C
	- Temperature (T <sub>L</sub> )	60 – 150 seconds
Peak Temperature (T <sub>P</sub> )		260±0/-5 °C
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		8 – 20 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T <sub>P</sub> )		8 minutes Max.
Do not exceed		260°C



Package Reel Information



REF	mm	inch
A	3.9±0.2	0.154±0.008
B	7.0±0.2	0.276±0.008
d	Φ1.5±0.1	Φ0.059±0.004
E	1.75±0.1	0.069±0.004
F	7.5±0.1	0.295±0.002
P	8.0±0.1	0.315±0.004
P0	4.0±0.1	0.157±0.004
P1	2.0±0.1	0.079±0.004
W	16.0±0.3	0.63±0.012
D	Φ330.0	Φ13.0
D1	Φ50Min	Φ1.97Min
D2	Φ13±0.15	Φ0.512±0.006
W1	20.8±2.0	0.819±0.079

OUTLINE	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)	CARTON SIZE(mm)		
				L	W	H
TAPING	2,000	32,000	330	360	360	380